



Results on Opto-Link R&D

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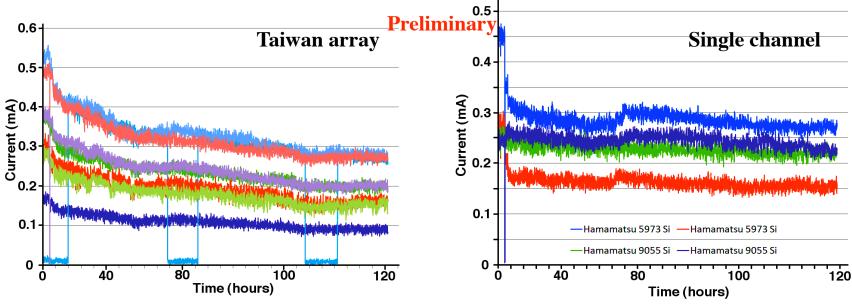




- Radiation hardness of PIN arrays
- Radiation hardness of VCSEL arrays
- Study of opto-chips
- Summary





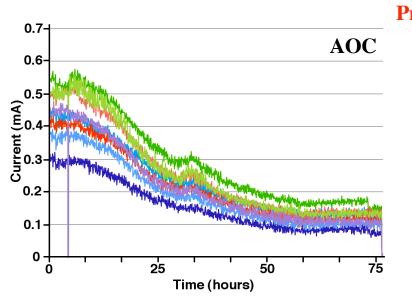


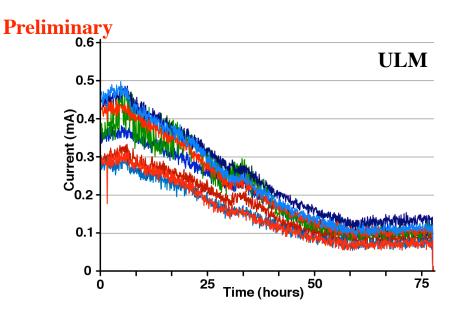
- irradiate PIN with 24 GeV protons at CERN
 - SLHC dosage: $2.6 \times 10^{15} \text{ p/cm}^2 (1.5 \times 10^{15} \text{ 1-MeV n}_{eq}/\text{cm}^2)$
 - ◆ 2007 irradiation with 60% higher dosage:
 - Taiwan array responsivity (A/W): decrease by a factor of 3
 - ◆ 2008 irradiation with SLHC dosage:
 - Taiwan array responsivity: decrease by a factor of 2
 - Hamamatsu device responsivity: decrease somewhat less
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Radiation-Hardness of GaAs PI







- irradiate PIN with 24 GeV protons at CERN
 - SLHC dosage: $2.6 \times 10^{15} \text{ p/cm}^2 (8.2 \times 10^{15} \text{ 1-MeV n}_{eq}/\text{cm}^2)$
 - ◆ 2007 irradiation with 60% higher dosage:
 - responsivity: decrease by a factor of 10
 - ◆ 2008 irradiation with SLHC dosage:
 - responsivity: decrease by a factor of 2-4

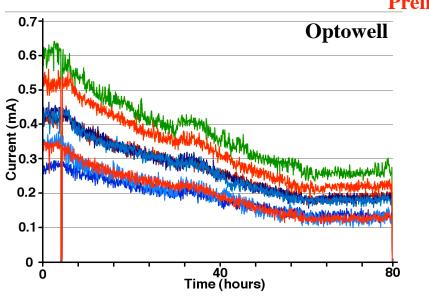
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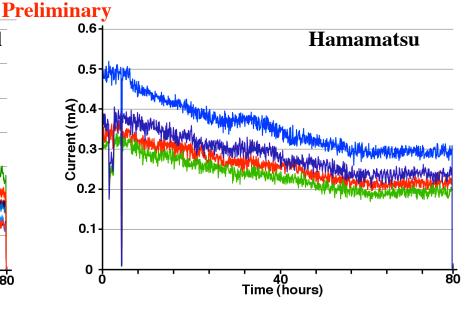
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- 2007 irradiation with 60% higher dosage:
 - Optowell responsivity: decrease by a factor of 10
- 2008 irradiation with SLHC dosage:
 - ◆ Optowell responsivity: decrease by a factor of ~2
 - ♦ Hamamatsu responsivity: decrease by a factor of ~1.6



Radiation-Hardness of PIN

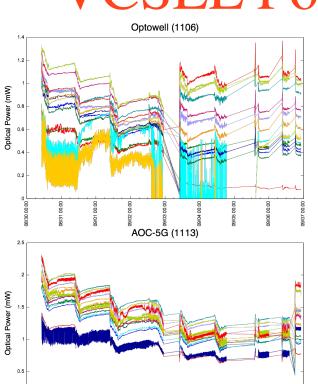


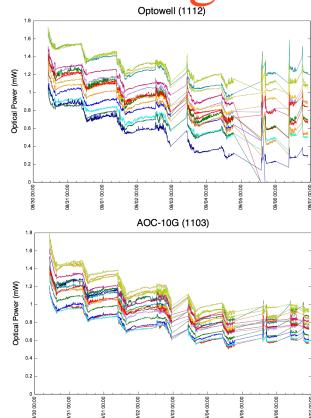
	Gb/s	Responsivity (A/W)	
GaAs		Pre	Post
ULM	4.25	0.50	0.13
AOC	2.5	0.60	0.19
Optowell	3.125	0.60	0.25
Hamamatsu G8921	2.5	0.50	0.32
Si			
Taiwan	1.0	0.55	0.33
Hamamatsu S5973	1.0	0.47	0.37
Hamamatsu S9055	1.5/2.0	0.25	0.21











- 2007 irradiation with 60% higher dosage:
 - close to zero power on some channels
- 2008 irradiation with SLHC dosage:
- ◆ AOC(5 & 10 G) have good power K.K. Gan TWEPP08



Opto-Chips

1.5 mm

 $0.13~\mu m$

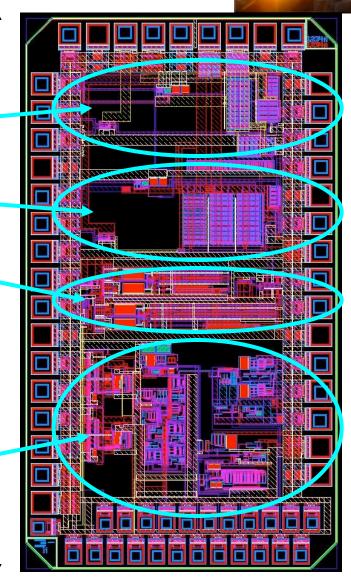
640 Mb/s VCSEL Driver

3.2 Gb/s VCSEL Driver

640 MHz clock multipliers (4 x 160 and 16 x 40 MHz)

2.6 mm

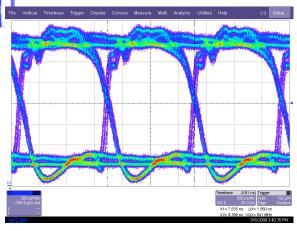
PIN receiver/decoder (40, 160, 320 MHz)

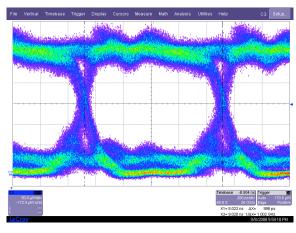


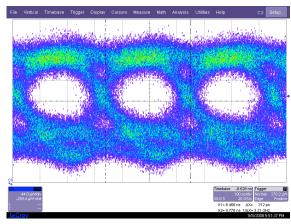
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Slow VDC 640 Mb/s

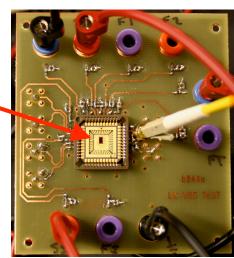
Fast VDC 1 Gb/s

Fast VDC 3.2 Gb/s

PLCC package.

- both chips are working in preliminary study
- LVDS receiver working at high speed
- need detailed study without package K.K. Gan

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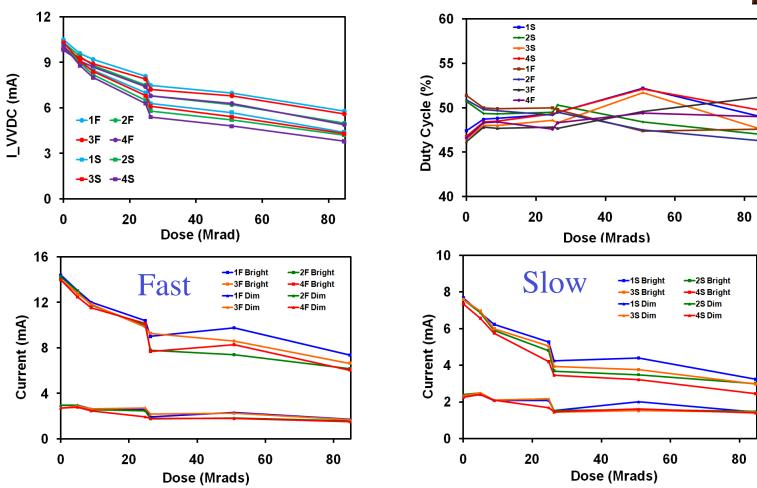
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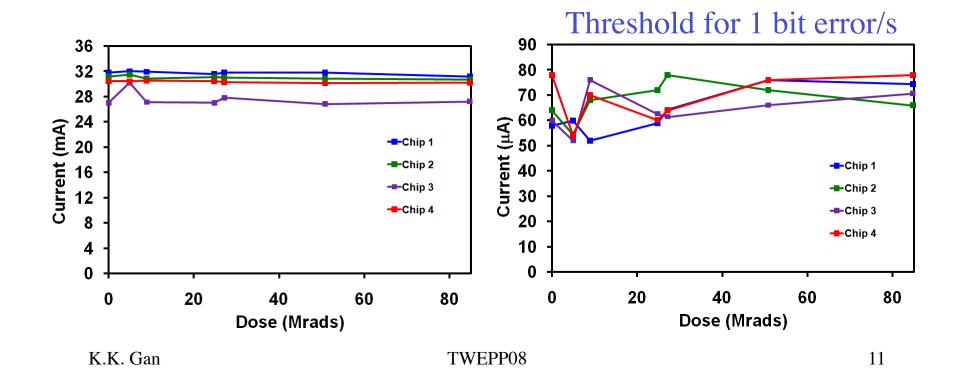
- drive current decreases with radiation for constant ISET
- need detailed study after cool down



Receiver/Decoder Chip



- Properly decode 40, 80, and 160 Mb/s signals but not 320 Mb/s
 - ◆ LVDS-like output has proper amplitude and baseline
 - ◆ small clock jitter (e.g. < 50 ps @ 160 MHz)
 - no significant degradation after irradiation

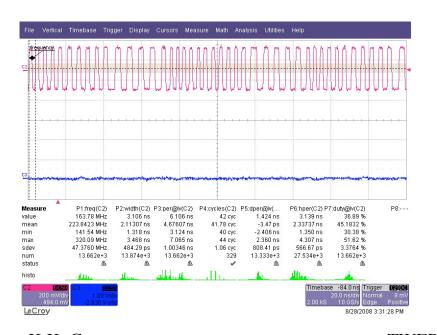


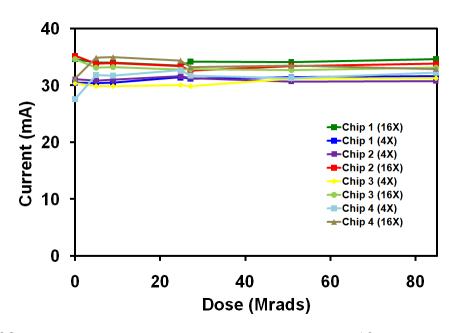






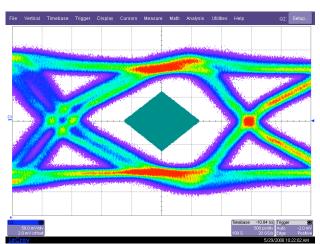
- Both 4 x and 16 x clock multipliers work
 - clock jitter < 8 ps (0.5%)
 - ◆ two of the four chips lost lock during irradiation
 - □ need power cycling to resume operation at 640 MHz
 - no change in current consumption

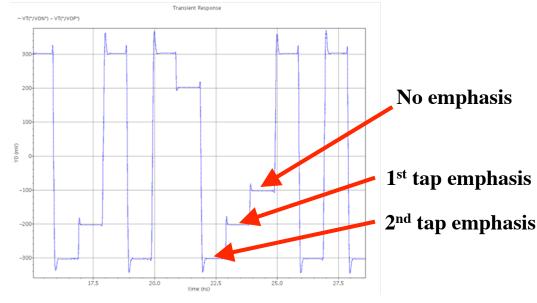






Skinny Wires with Pre-emphasis





320 Mb/s 4 m

- Signals from modules (320 Mb/s) can be transmitted up to ~ 4 m with pre-emphasis
 - minimum material
 - allow serializer chip to be placed further from the IP to reduce SEU

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Summary

- Good PIN candidates identified
- Good VCSEL candidates identified
- First 0.13 μm submission mostly successful
 - full characterization of pre/post irradiation in progress
 - aim for next iteration in winter 2009